#### 05/12/2015 503303684

# PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT3350302

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

#### **CONVEYING PARTY DATA**

Name	Execution Date
KALPANA MADHALAM	04/28/2015
RAHUL MAHASHABDE	05/06/2015
BALAJI PATTABHIRAMAN	05/05/2015
DEEPANKAR NARAYANAN	05/07/2015
VIRAD GUPTA	04/29/2015

#### **RECEIVING PARTY DATA**

Name:	Oracle International Corporation
Street Address:	500 Oracle Parkway
Internal Address:	Mail Stop 50P7
City:	Redwood Shores
State/Country:	CALIFORNIA
Postal Code:	94065

### **PROPERTY NUMBERS Total: 1**

Property Type	Number
Application Number:	14710448

### **CORRESPONDENCE DATA**

Fax Number: (650)842-0304

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 650-842-0300

Email: sherry@trellislaw.com CHARLES J. KULAS **Correspondent Name:** 

1900 EMBARCADERO ROAD Address Line 1:

Address Line 2: **SUITE 109** 

Address Line 4: PALO ALTO, CALIFORNIA 94303

ATTORNEY DOCKET NUMBER:	ORACP0127
NAME OF SUBMITTER:	SHERRY SUTTERFIELD
SIGNATURE:	/Sherry Sutterfield/
DATE SIGNED:	05/12/2015

## **Total Attachments: 6**

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#### ASSIGNMENT OF APPLICATION FOR PATENT

WHEI	REAS: <u>Kalpana Madhalam</u> – Parramatta, Australia
	Rahul Mahashabde – Bangalore, India
	Balaji Pattabhiraman – Bangalore, Karnataka, India
	<u>Deepankar Narayanan</u> – Trivandrum, Kerala, India
	<u>Virad Gupta</u> – Fremont, CA USA
	(full name(s) and city and state of residence of inventor(s) (including country))
(hereii	nafter referred to as ASSIGNOR(S)), has made a discovery and/or invention entitled:
	HIERARCHICAL DIMENSION ANALYSIS IN MULTI-DIMENSIONAL PIVOT GRIDS
	for which application for Letters Patent of the United States has been executed on,
$\boxtimes$	for which application for Letters Patent of the United States has been filed on, under Application No, and
WHEI	REAS: Oracle International Corporation, a corporation of California, having a business address of 500 Oracle Parkway, Mail Stop 5OP7, Redwood Shores, CA 94065
to as A	hich, together with its successors, assigns, and legal representatives, is hereinafter referred ASSIGNEE, is desirous of acquiring the entire right, title and interest in, to and under said ion and in, to and under Letters Patent or similar legal protection to be obtained therefor in aited States and in any and all foreign countries.

### NOW, THEREFORE, TO ALL WHOM IT MAY CONCERN:

Be it known that for good and valuable consideration, the receipt of which is hereby acknowledged, ASSIGNOR(S) hereby sells, assigns and transfers to ASSIGNEE, the full and exclusive right, title and interest to said discovery or invention in the United States and its territorial possessions and in all foreign countries and to all Letters Patent or similar legal protection in the United States and its territorial possessions and in any and all foreign countries to be obtained for said invention by said application or any continuation, continuation-in-part, divisional, reexamination, renewal, substitute, reissue and/or any application claiming priority thereof, including any legal equivalent thereof, in a foreign country for the full term or terms for which the same may be granted.

Oracle Matter No. **ORA141024-US-NP** 

I. SAID ASSIGNOR(S), hereby authorize and request the Commissioner of Patents and Trademarks of the United States of America and any Official of any country or countries foreign to the United States of America whose duty it is to issue Letters Patent on applications as aforesaid, to issue all such Letters Patent for said discovery or invention to the ASSIGNEE, as assignee of the entire right, title and interest in, to and under the saine, for the sole use and benefit of the ASSIGNEE in accordance with the terms of this instrument.

I, SAID, ASSIGNOR(S), hereby covenant with ASSIGNEE that no assignment, grant, mortgage, license, or other agreement affecting the rights and property herein conveyed has been made to others by the undersigned and that I have full right to convey the eatire right, title and interest berein sold, assigned, transferred and set over;

AND L SAID ASSIGNOR(S) hereby further covenant and agree that the ASSIGNEE may apply for foreign Letters Patent on said discovery or invention and claim the benefits of the International Convention, and that I will, at any time, when called apon to do so by the ASSIGNEE communicate to the ASSIGNEE as the case may be, any facts known to me respecting said discovery or invention, and execute and deliver any and all lawful papers that may be necessary or desirable to perfect the title to the said discovery or invention, the said applications and the said Letters Patent in the ASSIONEE and that if reissues or reexaminations of the said Letters Patent or disclaimers relating thereto, or divisionals, continuations, continuation in parts of the said applications shall bereafter be desired by the ASSIGNEE, I will, at any time, when called upon to do so by the ASSIGNEE sign all lawful papers, make all rightful oaths, execute and deliver all such disclaimers and all divisional, continuation, continuation-in-part, reexamination, and reissue applications so desired, and do all lawful acts requisite for the application for such continuations, continuation-in-parts, divisionals, reexaminations, or reissues and the procuring thereof and for the filing of such disclaimers and such applications, and generally do everything possible to aid the ASSIGNEE to obtain and enforce proper patent protection for said invention or discovery in all countries, all without further compensation but at the expense of the ASSIGNEE.

ASSIGNOR hereby authorizes and requests the prosecuting law from to insert herein above the application number and filing date of said application when knows.

Inventor(s): Please Sign <u>and Date</u> Below:

(1)	M. Kalpany	Date:	23/04/2015	
	Kalpana Madhalam		\$ 1 8 \$ 100 Oct	

Oracle Matter No. ORA141024-US-NP

3

(2)

Date: 06/05/2015

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Oracle Matter No. ORA141024-US-NP

(5) Virad Gupta Date: 4/29/2015

Oracle Matter No. ORA141024-US-NP

**RECORDED: 05/12/2015**